

Antenna

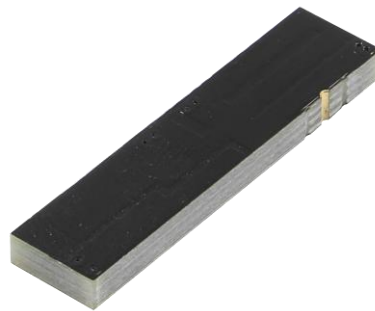
YC0001AA Datasheet

Antenna Services

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About the Document

Revision History

Version	Date	Author	Note
1.0	2020-05-28	Kenny YIN	Initial
2.0	2020-06-22	Kenny YIN	Updated the specifications.
2.1	2020-12-11	Kenny YIN	Updated the antenna image (Chapter 2).
2.2	2021-01-27	Kenny YIN	Added the return loss data, pattern laboratory pictures, package parameters.
2.3	2021-03-17	Kenny YIN	Updated the product height tolerance (Chapter 12).
2.4	2021-07-12	Aria CHU	Updated the drawing (Chapter 12).
2.5	2021-12-06	Aria CHU	Updated the product description (Chapter 1).
3.0	2022-10-08	Andy YAN	Update the test data (Chapter 4).

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1 Product Description

This Quectel embedded 4G SMD antenna covers main 4G LTE bands and is compatible with 3G/2G/LPWA bands. Featuring high efficiency and gain, it is an ideal antenna for a smooth and stable connection with high-efficiency data transmission even under the influence of the device's internal structure. Ground plane dependent, it's designed to be mounted directly to the device host PCB using a conventional PCB reflow process. Supplied tape and reel for high volume pick and place assembly, this SMD antenna can be tuned specifically for the final device environment with a simple PI matching circuit.

2 Product Features

- Cellular LTE
- High efficiency
- Excellent performance



3 Product Specifications

Passive Electrical Specifications

Frequency Range	698–960 MHz, 1710–2690 MHz
Input Impedance	50 Ω
VSWR	≤ 4.0
Gain	≤ 3.0 dBi
Polarization Type	Linear

Mechanical Specifications

Antenna Size	35.0 mm (L) \times 8.5 mm (W) \times 3.0 mm (H)
Material	FR4
Connector Type	SMD
Working Temperature	-40 $^{\circ}$ C to +85 $^{\circ}$ C
Color	Black

4 Overall Performance

4.1. Test Environment

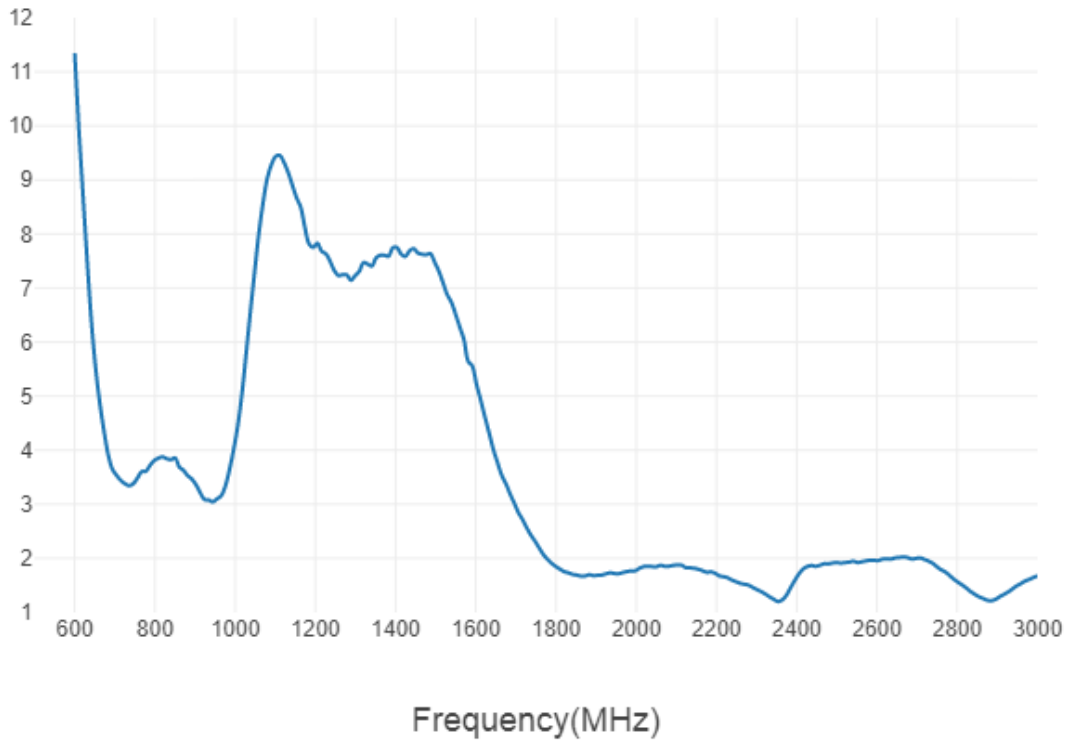
- KEYSIGHT ENA Network Analyzer E5063A 100 kHz – 8.5 GHz.
- RayZone®2800 Chamber 5G (FR1) SISO/MIMO, 600 MHz – 8.5 GHz.



4.2 VSWR

- Board length 110 mm.

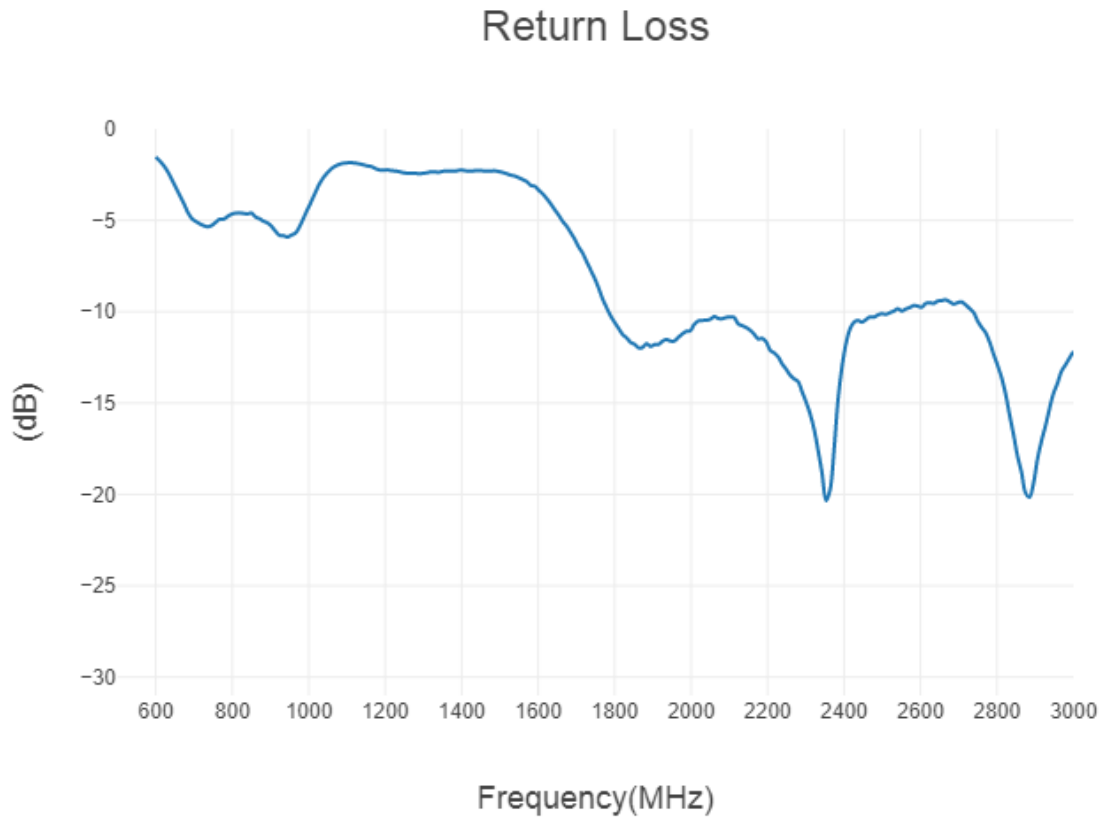
VSWR



Frequency (MHz)	700	830	960	1710	1950	2170	2300	2690
VSWR	3.6	3.8	3.1	2.51	1.8	2.8	1.4	2.0

4.3 Return Loss

- Board length 110 mm.

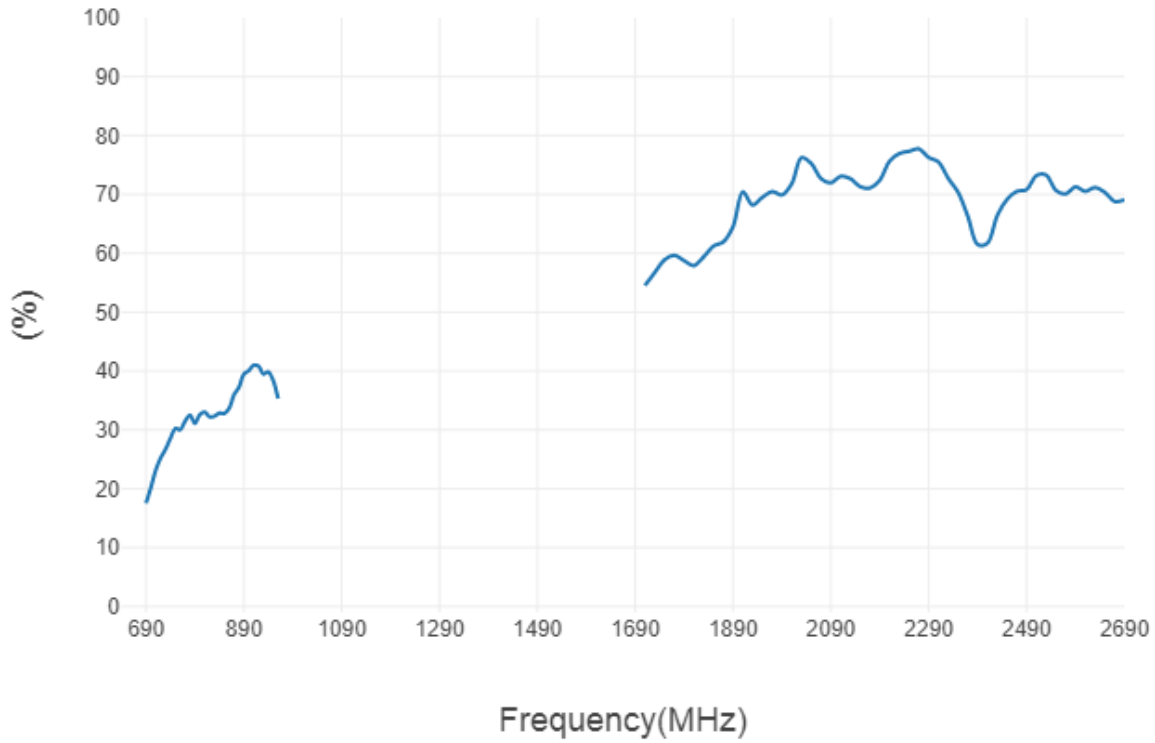


Frequency (MHz)	700	830	960	1710	1950	2170	2300	2690
Return Loss(dB)	-4.9	-4.9	-5.8	-6.5	-12	-11.5	-14.9	-9.5

4.4 Efficiency

- Board length 110 mm.

Efficiency

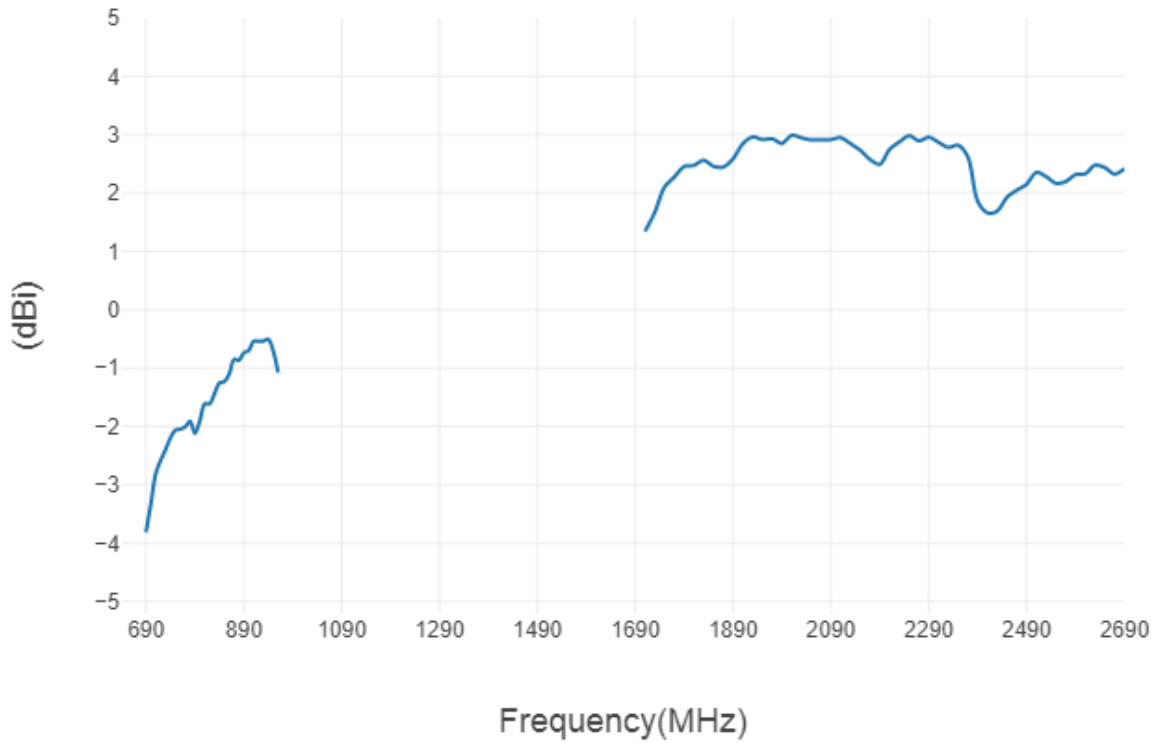


Frequency (MHz)	700	830	960	1710	1950	2170	2300	2690
Efficiency (%)	21.4	32.3	35.3	54.5	69.5	71.1	75.5	69.1

4.5 Peak Gain

- Board length 110 mm.

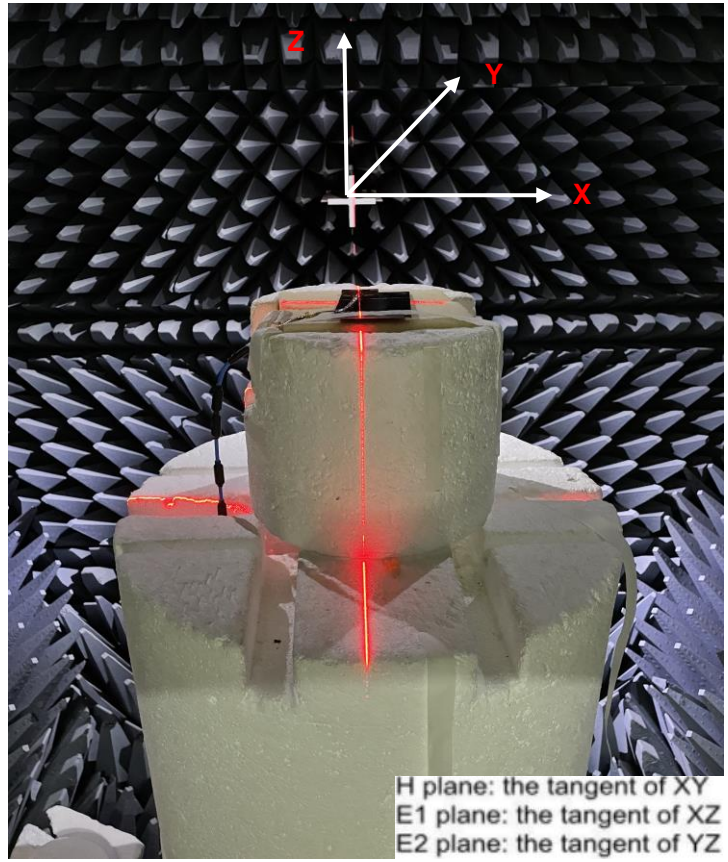
Peak Gain



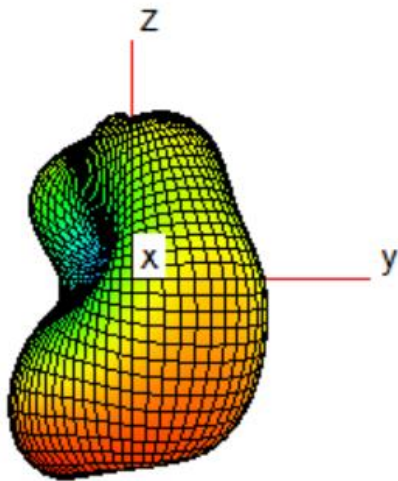
Frequency (MHz)	700	830	960	1710	1950	2170	2300	2690
Peak Gain (dBi)	-3.32	-1.43	-1.07	1.34	2.91	2.57	2.87	2.42

4.6 Radiation Patterns

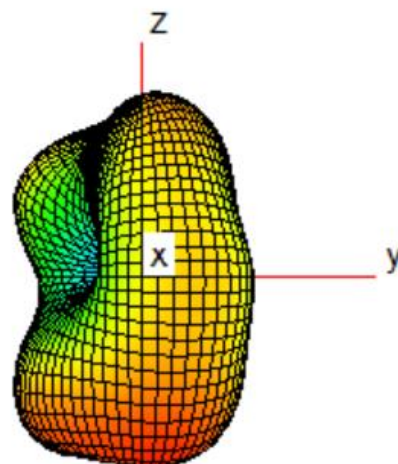
- Board length 110 mm.



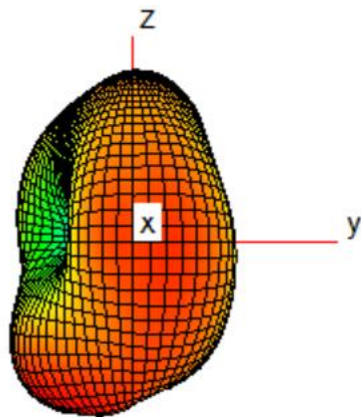
700 MHz



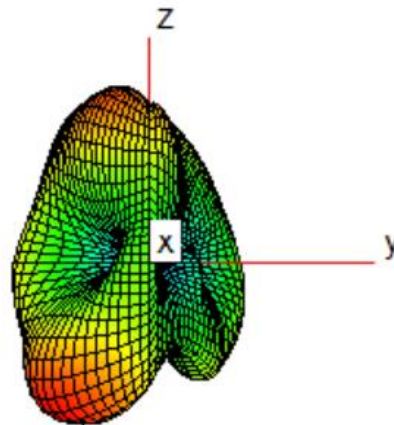
830 MHz



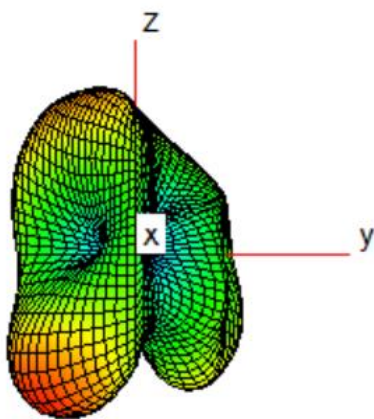
960 MHz



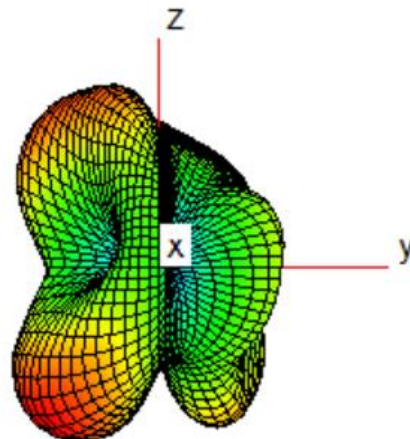
1710 MHz



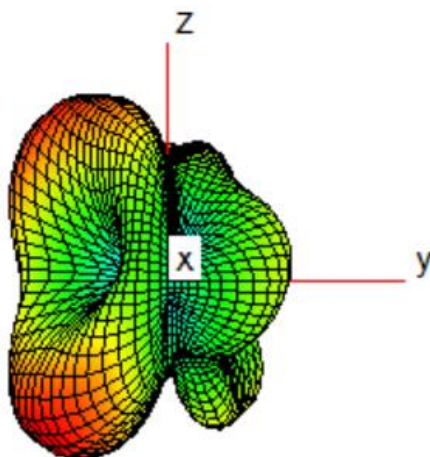
1950 MHz



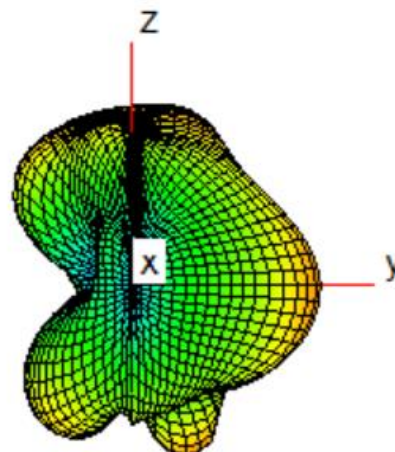
2170 MHz



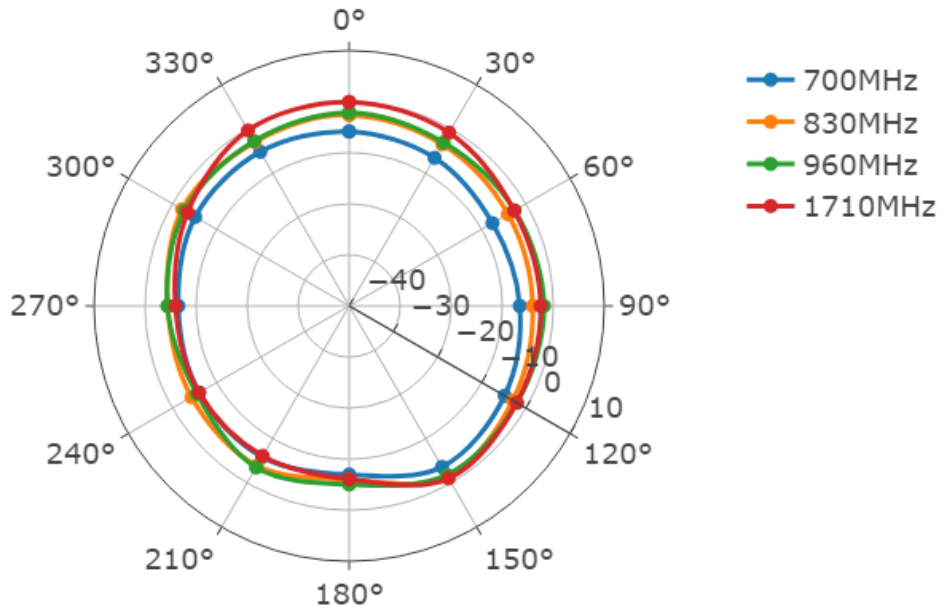
2300 MHz



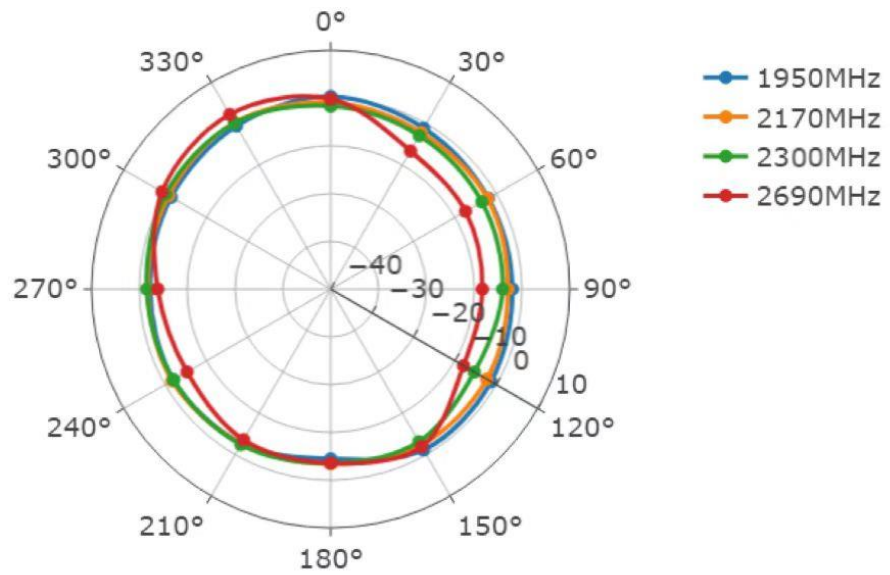
2690 MHz



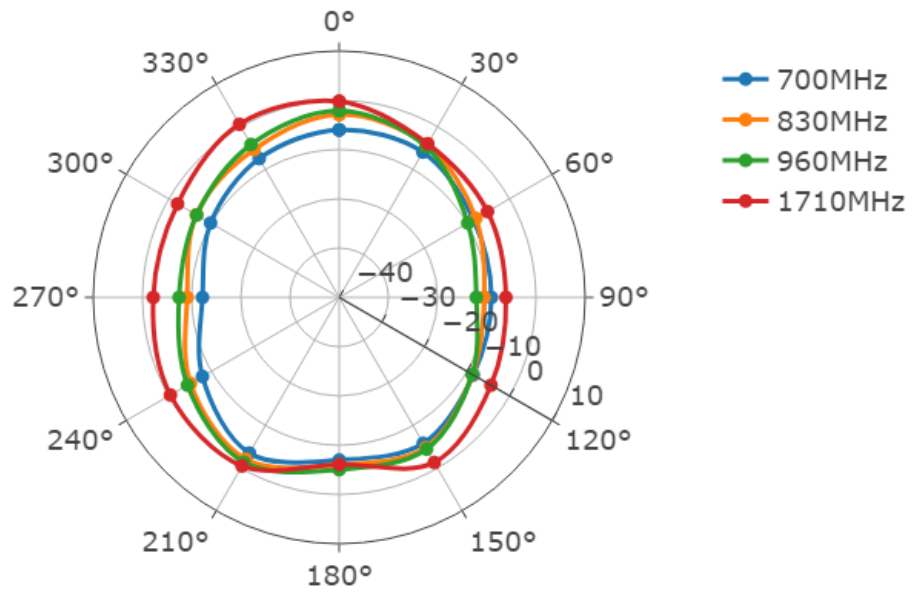
E1 Plane:XZ



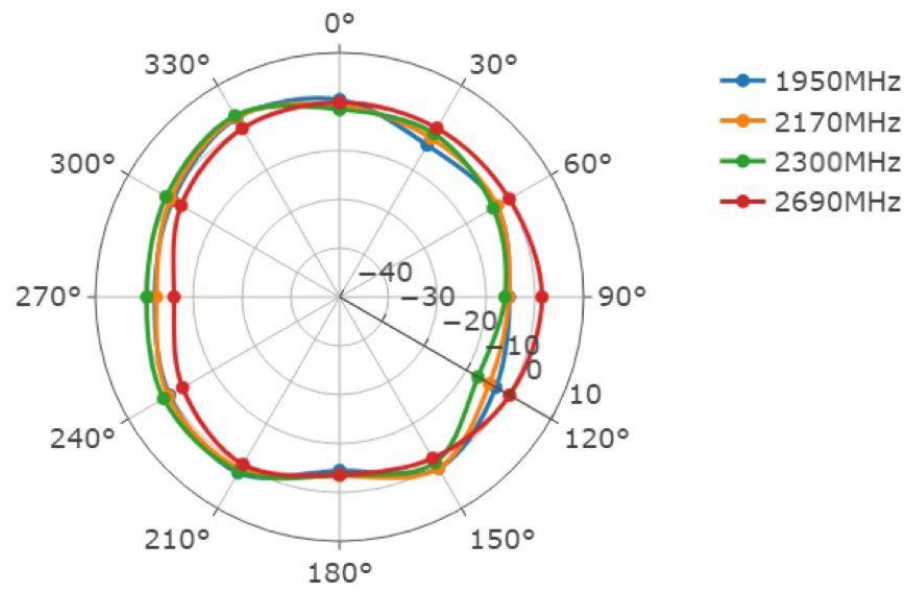
E1 Plane:XZ



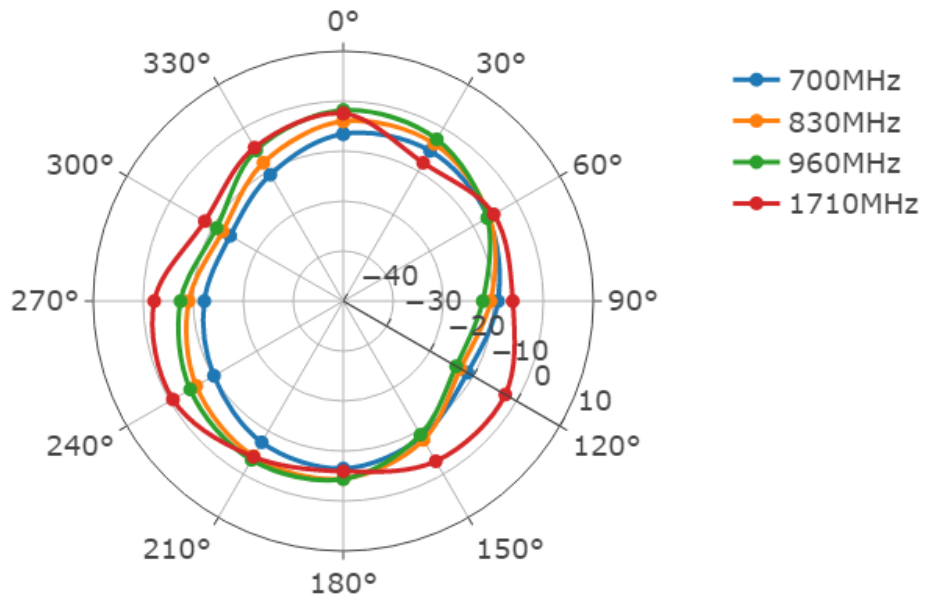
E2 Plane:YZ



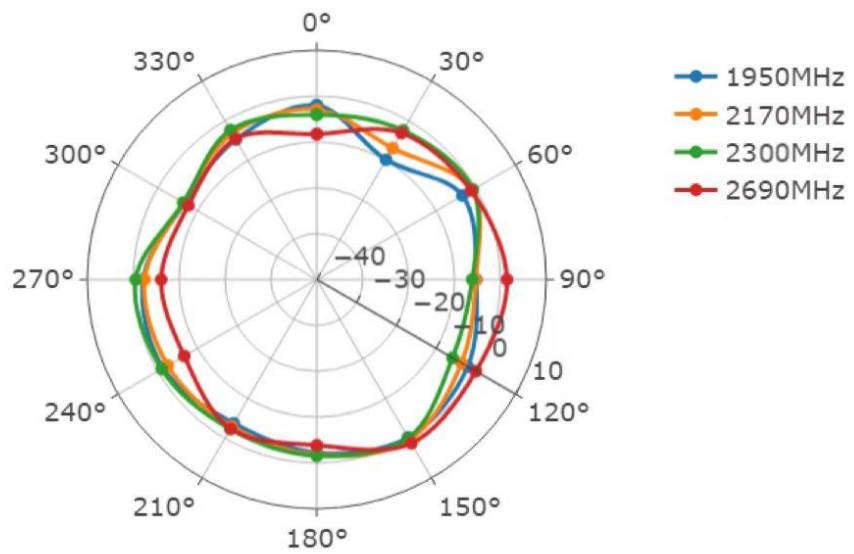
E2 Plane:YZ



H Plane:XY

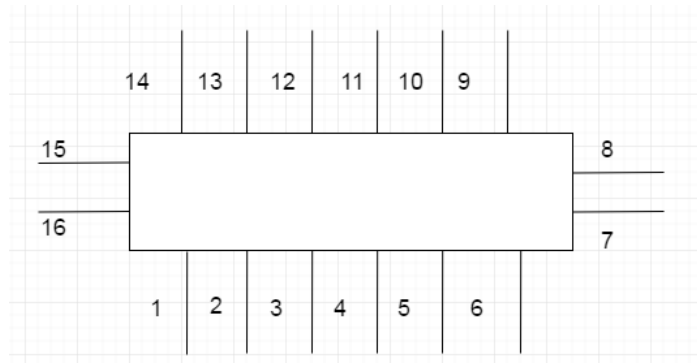


H Plane:XY



5 Schematic Symbol and Pin Definition

The pin assignment for the antenna is as follows. The antenna has 16 pins and only two work. All other pins are designed for mechanical strength.

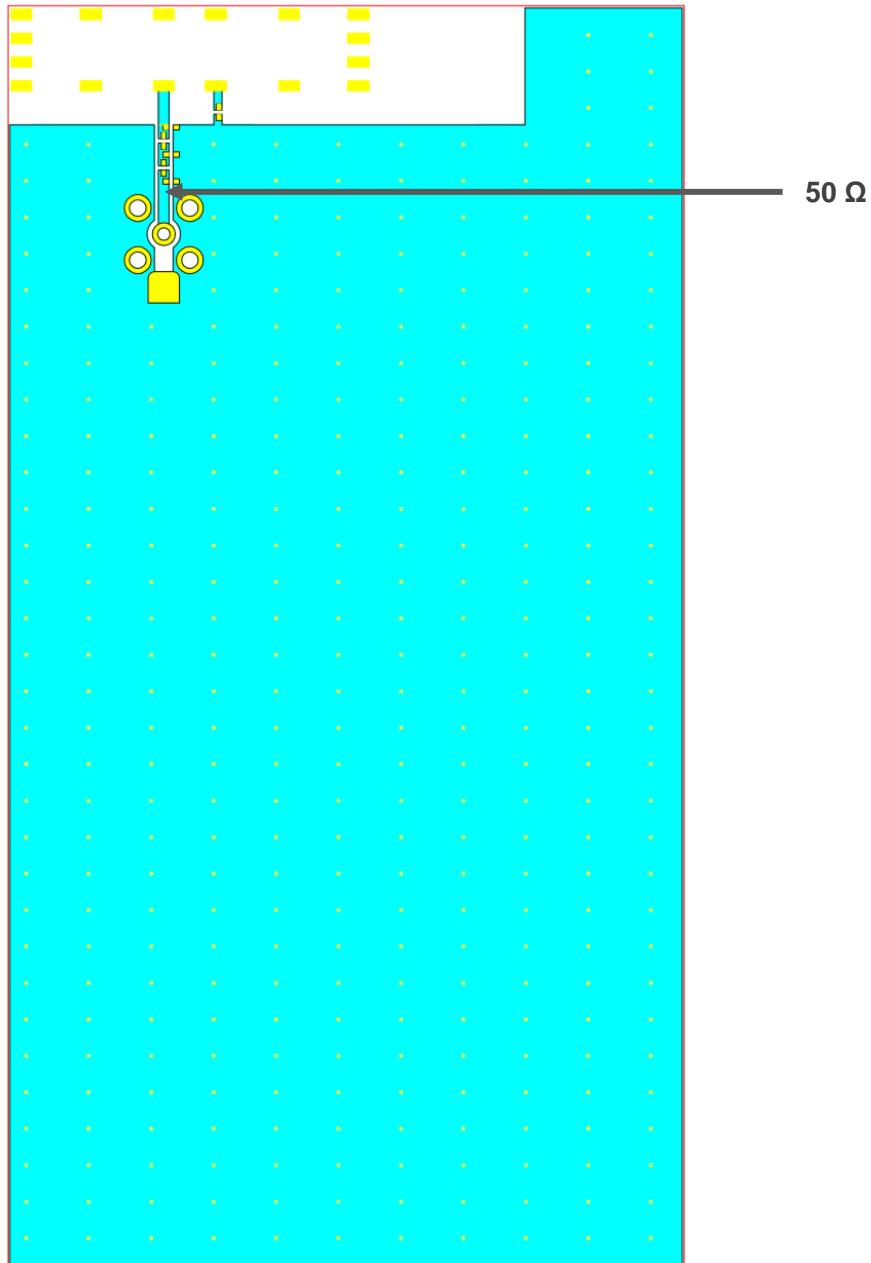


Pin No.	Description
3	Feed
4	Return/GND
1, 2, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16	Not used (mechanical only)

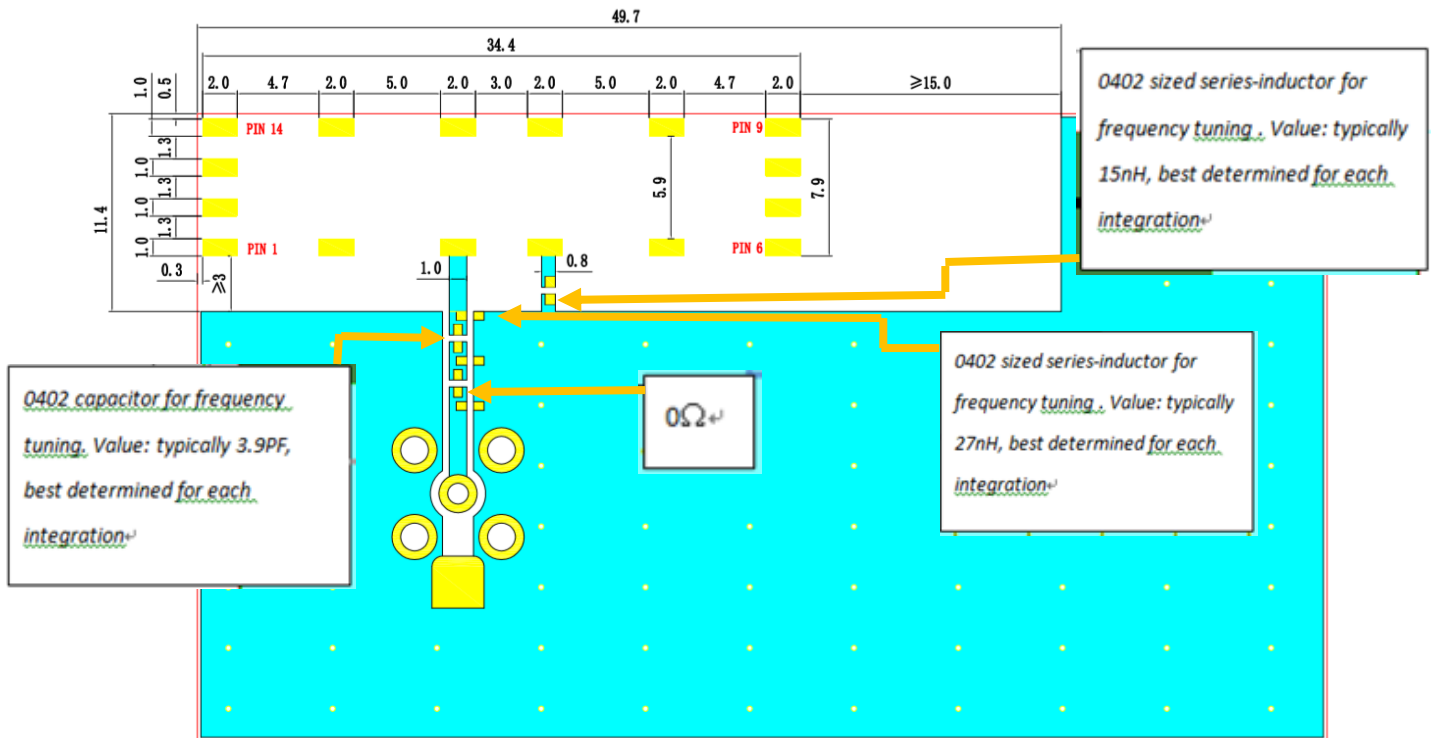
6 Transmission Line

The characteristic impedance of all transmission lines shall be designed as 50 Ω .

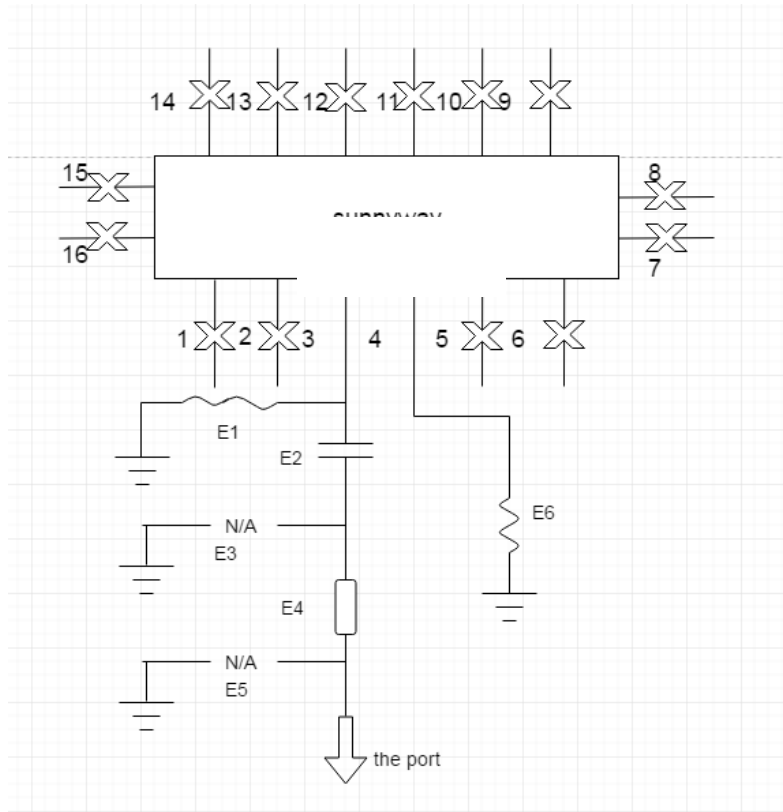
- The length of the transmission lines should be kept to as short as possible.
- Any other part of the RF system, such as transceiver, power amplifiers, etc., shall also be designed with an impedance of 50 Ω .



7 Matching Circuit



The antenna requires a matching circuit that must be optimized for each product. The matching circuit will require up to six components and the following circuit should be designed into the host PCB. Not all components may be required but should be included as a precaution. The matching network must be placed close to the antenna feed to ensure it is more effective in tuning the antenna.

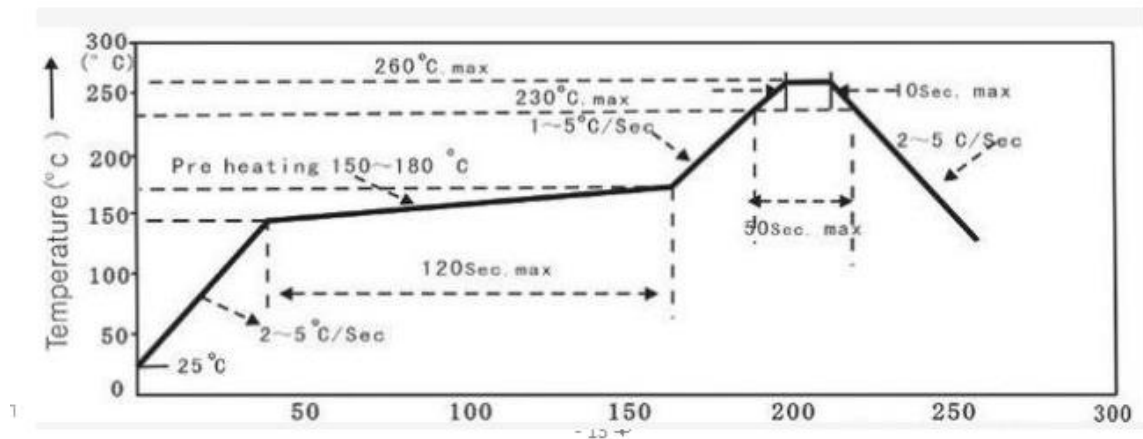


	Type	Value
E1	Inductor	27 nH
E2	Capacitor	3.9 pF
E3	-	-
E4	Resistor	0 Ω
E5	-	-
E6	Inductor	15 nH

9 Soldering Temperature

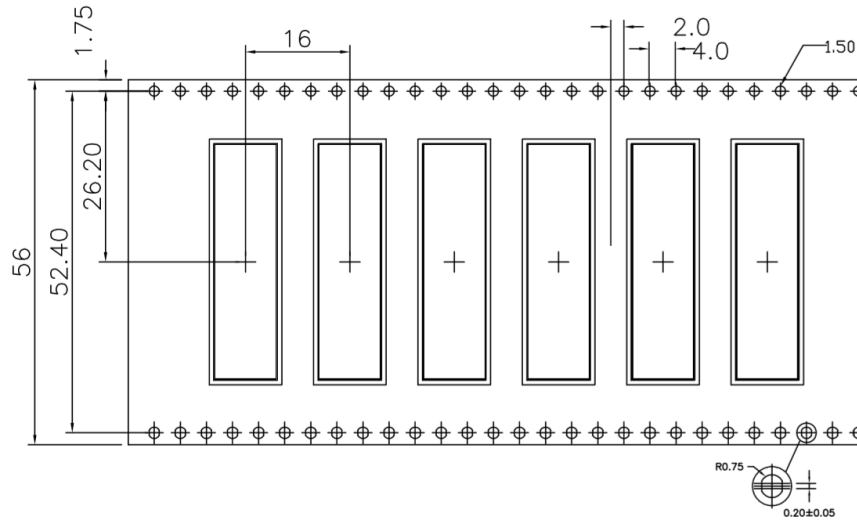
Phase	Profile Features	PB-Free Assembly (Max.)
RAMP-UP	Avg. Ramp-up Rate (T _{smax} to T _p)	3 °C/second (Max.)
PREHEAT	Temperature Min. (T _{smin})	150 °C
	Temperature Max. (T _{smax})	180 °C
	Time (T _{smin} to T _{smax})	120 seconds (Max.)
REFLOW	Temperature (TL)	210 °C
	Total Time above TL (tl)	50 seconds (Max.)
PEAK	Temperature (T _p)	260 °C
	Time (t _p)	10 seconds (Max.)
RAMP-DOWN	Rate	5 °C/second (Max.)

10 Reflow Profile

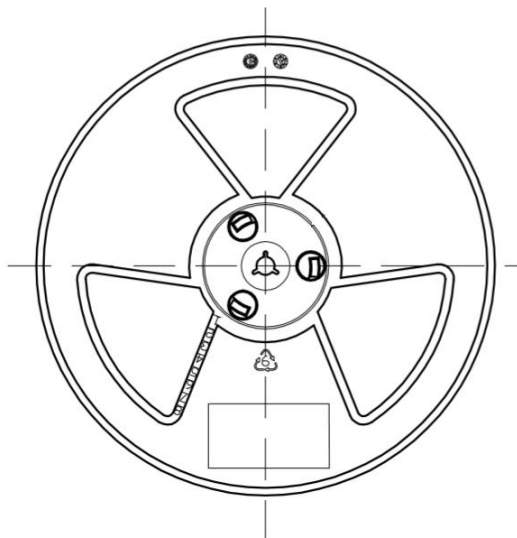


11 Package

- Quantity/Reel: 1000 pcs/Reel
- Carrier tape dimensions (mm)



- Taping reel dimensions (mm)



330 mm x 56.4 mm

12 Product Size (Unit: mm)

